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Sam Chou	EMERGING DISPLAY	ISSUE: SEP.08, 2020
ROVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 31
This the		VERSION: 3
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
	DEL NO.:  ET035013DHA (RoHS)  MESSRS:	orthonalion only.

#### MODEL NO. VERSION **PAGE** EMERGING DISPLAY TECHNOLOGIES CORPORATION ET035013DHA 3 0 - 1DOC . FIRST ISSUE JAN.15, 2019 RECORDS OF REVISION **REVISED** DATE **PAGE** SUMMARY NO. JUN.25, 2019 2 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS POWER SUPPLY VOLTAGE -0.3 IO SUPPLY VOLTAGE LED BACKLIGHT POWER VDDI -0.3PD mW 465 DISSIPATION LED BACKLIGHT FORWARD ILED 30 mA CURRENT LED BACKLIGHT REVERSE VR v 30 VOLTAGE SYMBOI REMARK MIN MAX. UNIT POWER SUPPLY VOLTAGE POWER DISSIPATION FOR LED VDD-VS PD 465 mW BACKLIGHT FORWARD CURRENT FOR LED ILED 30 mA REVERSE VOLTAGE FOR LED NOTE (1): LCM SHOULD BE GROUND DURING HANDLING LCM→ LCM SHOULD BE GROUND DURING LCM HANDLING 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS OPERATIN STORAGE REMARK MIN. MIN MAX. MAX. ~20Hz , 1HR :0~500Hz(20Hz) , 1HR :0~500Hz(500Hz) , 1HR ;(X,Y,Z,TOTAL 3HRS 2.45m/s<sup>2</sup> ( 0.25G) 11.76m/s<sup>2</sup> ( 1.2G ) VIBRATION 10 ms XYZ DIRECTIONS 1 TIME EACH 29.4m/s<sup>2</sup> (3G) SHOCK STORAGE MIN. OPERATING MIN. MA ITEM REMARK MAX 10~100Hz , 1HR XYZ DIRECTIONS 1 HR EACH 2.45m/s<sup>2</sup> ( 0.25G) 10 ms XYZ DIRECTIONS 1 TIME EACH 490.0m/s<sup>2</sup> ( 50G ) 29.4m/s (3G) SHOCK 4. ELECTRICAL CHARACTERISTICS UNIT REMARK ITEM CONDITION MIN ANALOG POWER SUPPLY DIGITAL POWER SUPPLY LOGIC HIGH INPUT VDDI 3.0 3.3 3.6 VIH H LEVEL 0.7VDDI v NOTE (1) VOLTAGE LOGIC LOW INPUT VII. LIEVEL 0.3VDDI v NOTE (1) VOLTAGE I OGIC HIGH OUTPUT VOH VDDI VOLTAGE LOGIC LOW OUTPUT VOLTAGE ANALOG OPERATING IDD VDD=3.3V 20 30 mA NOTE (2) CURRENT DIGITAL OPERATING IDDI VDDI=3.3V NOTE (2) 1 2 mA POWER SUPPLY FOR LED VLED-VLSS ILED=20mA 18.6 18.0 v NOTE (1) BACKLIGHT LED LIFE TIME ILED=20mA 30K 40K HRS CONDITION SYMBOL MIN TYP. MAX. UNIT REMARK POWER SUPPLY VOLTAGE VDD-VSS 3.3 V LOGIC HIGH INPUT VOLTAGE LOGIC LOW INPUT NOTE (1) VII NOTE (1) VOLTAGE LOGIC HIGH OUTPUT V<sub>OH</sub> VDD I<sub>OH</sub>=-1.0mA VDD-0.4 VOLTAGE LOGIC LOW OUTPUT Vol VSS VSS+0.4 $I_{OL}=+1.0mA$ v VOLTAGE VDD-VSS POWER SUPPLY CURRENT IDD 20 30 mA NOTE (2) =3.3V POWER SUPPLY VOLTAGE VLED-VLSS ILED=20mA 18.0 18.6 V NOTE (1) FOR LED BACKLIGHT LED LIFE TIME 30K 40K HRS NŌTE ( 5 ) : TA=25 °C $\rightarrow$ Ta=25 °C 8,9 6.1 OPTICAL CHARACTERISTICS MAX. UNIT REMARK TYP. θx=0°, θy=0° VDD=3.3V 0.33 0.38 0.28 COLOR OF CIE COORDINATE NOTE (5) VDD1=3.3V Wy 0.30 0.35 0.40 CENTER) ILED=20mA SYMBOI CONDITION MIN. TYP. MAX. UNIT REMARK θx=0°, θy=0° VDD=3.3V COLOR OF CIE COORDINATE WHITE 0.35 0.25 0.30 NOTE (5) VDD1=3.3V Wy 0.31 0.36 (CENTER) 0.26 ILED=20mA NOTE (7): IF=200mA→ILED=20mA

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TECHNOLOGIES	CORPORATION

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### 1. GENERAL SPECIFICATIONS

1.1 DATA SHEET FOR CONTROLLER/DRIVER PLEASE REFER TO :

### SITRONIX ST7272A-G4

1.2 MATERIAL SAFETY DESCRIPTION

ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS, INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD, MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED BIPHENYLS (PBB) AND POLYBROMINATED DIPHENYL ETHERS (PBDE), BIS(2-ETHYLHEXYL) PHTHALATE (DEHP), BUTYL BENZYL PHTHALATE (BBP), DIBUTYL PHTHALATE (DBP), DIISOBUTYL PHTHALATE (DIBP).

### 2. MECHANICAL SPECIFICATIONS

(1) DISPLAY SIZE	3.5 inch
(2) NUMBER OF DOTS	320W * (RGB) * 240H DOTS
(3) MODULE SIZE	76.8W * 63.8H * 4.4D mm
	(WITHOUT FPC)
(4) VIEWING AREA	71.6W * 54H mm
(5) ACTIVE AREA	70.08W * 52.56H mm
(6) DOT SIZE	0.073W * 0.219H mm
(7) PIXEL SIZE	0.219W * 0.219H mm
(8) LCD TYPE	TFT, TRANSMISSIVE,
	NORMALLY BLACK
(9) COLOR	16.7M
(10) VIEWING DIRECTION	SUPER WIDE VIEW
(11) BACK LIGHT	LED , COLOR : WHITE
(12) INTERFACE MODE	RGB 24BIT PARALLEL (DE/SYNC MODE)

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### 3. ABSOLUTE MAXIMUM RATINGS

### 3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	-0.3	4	V	_
STATIC ELECTRICITY		_		V	NOTE (1)
POWER DISSIPATION FOR LED BACKLIGHT	PD	_	465	mW	_
FORWARD CURRENT FOR LED BACKLIGHT	ILED	_	30	mA	- 14
REVERSE VOLTAGE FOR LED BACKLIGHT	VR	_	30	V	90,

NOTE (1): LCM SHOULD BE GROUND DURING LCM HANDLING.

### 3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ITEM	OPERATING		STORAGE		REMARK	
HEM	MIN.	MAX.	MIN.	MAX.	KEWIAKK	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE (1), (2)	
HUMIDITY	NOTI	E(3)	NOTI	-(.63.)	WITHOUT CONDENSATION	
VIBRATION		2.45m/s <sup>2</sup> ( 0.25G)	900	11.76m/s <sup>2</sup> (1.2G)	10~100Hz , 1HR XYZ DIRECTIONS 1 HR EACH	
SHOCK		29.4m/s <sup>2</sup> ( 3G)		490.0m/s <sup>2</sup> (50G)	10 ms XYZ DIRECTIONS 1 TIME EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE		

NOTE (1): Ta AT -30°C: WILL BE 48HRS MAX.

80°C: WILL BE 168HRS MAX.

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE.

NOTE (3):  $Ta \le 60^{\circ}C : 90\%RH \text{ MAX } (96HRS \text{ MAX}).$ 

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY

OF 90%RH AT 60°C(96HRS MAX).

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### 4. ELECTRICAL CHARACTERISTICS

 $Ta = 25 \, ^{\circ}C$ 

							1a-25 C
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	_	3.0	3.3	3.6	V	
LOGIC HIGH INPUT VOLTAGE	$V_{\mathrm{IH}}$		0.7VDD	_	_	V	NOTE (1)
LOGIC LOW INPUT VOLTAGE	$V_{\rm IL}$		_		0.3VDD	V	NOTE (1)
LOGIC HIGH OUTPUT VOLTAGE	$V_{OH}$	I <sub>OH</sub> =-1.0mA	VDD-0.4		VDD	V	
LOGIC LOW OUTPUT VOLTAGE	$V_{OL}$	I <sub>OL</sub> =+1.0mA	VSS		VSS+0.4	V	73.
POWER SUPPLY CURRENT	IDD	VDD-VSS =3.3V	_	20	30	mA	NOTE (2)
POWER SUPPLY VOLTAGE FOR LED BACKLIGHT	VLED-VLSS	ILED=20mA	_	18.0	18.6	V	NOTE (1)
LED LIFE TIME		IF=20mA (PER LED)	30K	40K	9,0	HRS	NOTE (5) NOTE (6)

NOTE (1): APPLIED TO TERMINALS /RESET, B7~B0, G7~G0, R7~R0, DCLK, HSYNC, VSYNC, ENB, SHUT.

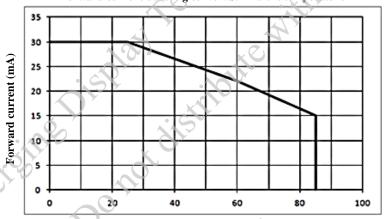
NOTE (2): THE DISPLAY PATTERN IS ALL "WHITE".

NOTE (3): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



NOTE (4): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT. (PER LED)

Forward current derating curve VS.Ambient temperature



Ambient temperature Ta(°C)

NOTE (5): CONDITIONS; Ta=25 °C, CONTINUOUS LIGHTING.

NOTE (6): DEFINITIONS OF LIFE TIME:

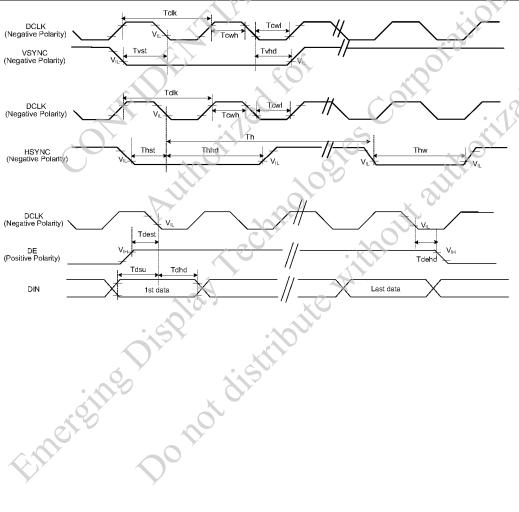
LCM LUMINANCE BECOMES HALF OF THE INITIAL VALUE.

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### 5. TIMING CHARACTERISTICS

### 5.1 PIXEL TIMING

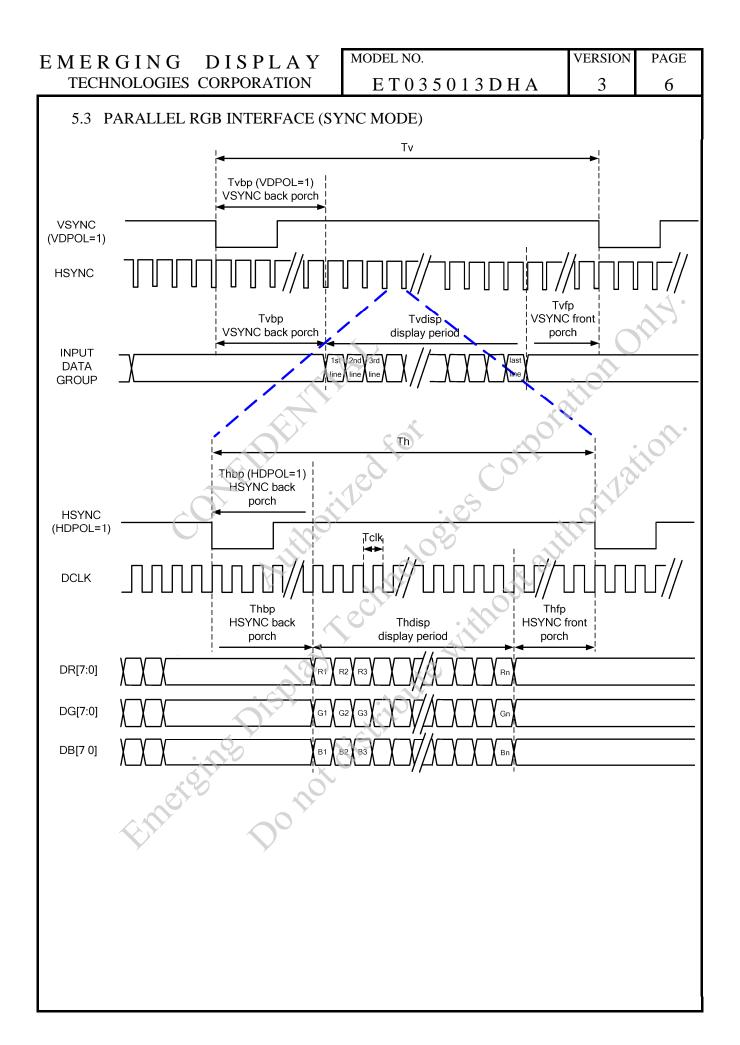
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
CLK PULSE DUTY	Tclk	40	50	60	%
HSYNC WIDTH	Thw	2	_	_	DCLK
HSYNC PERIOD	Th	55	60	65	us
VSYNC SETUP TIME	Tvst	12		_	ns
VSYNC HOLD TIME	Tvhd	12		_	ns
HSYNC SETUP TIME	Thst	12		_	ns
HSYNC HOLD TIME	Thhd	12		_	ns
DATA SETUP TIME	Tdsu	12	_	_	ns
DATA HOLD TIME	Tdhd	12	_	_	ns
DE SETUP TIME	Tdest	12	_	_	ns
DE HOLD TIME	Tdehd	12			ns

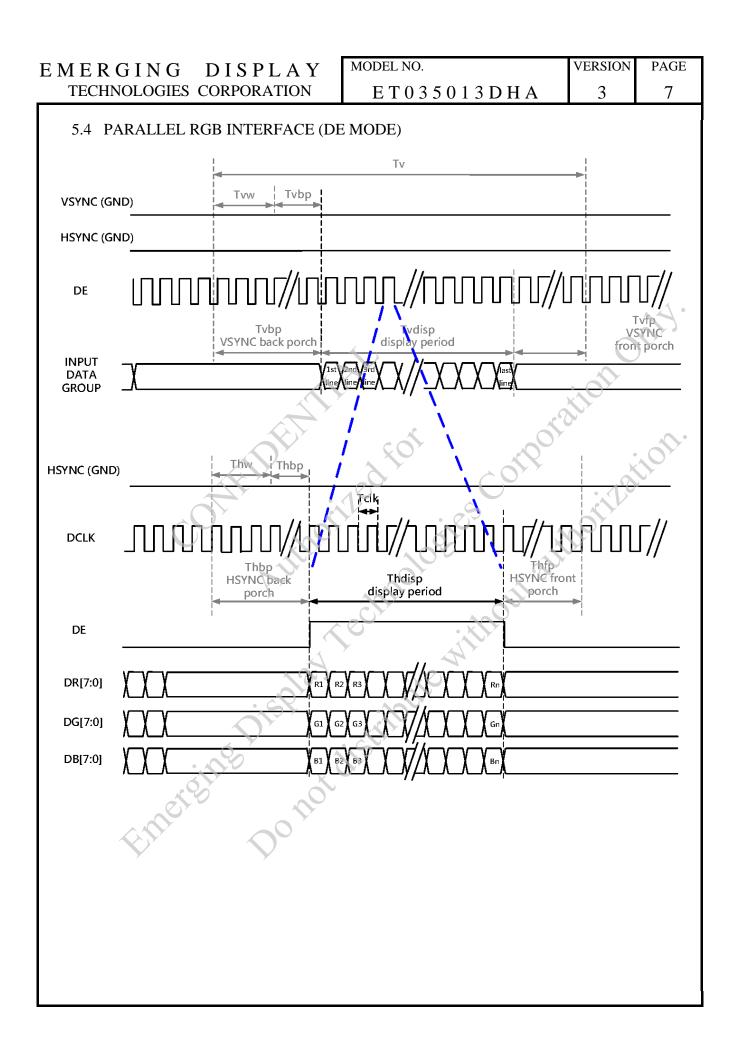


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#### 5.2 PARALLEL 24-bit RGB INPUT TIMING TABLE

	ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
DCLK FRE		Fclk	5	6	8	MHz	NOIE
DCLK PER		Tclk	125	167	200	ns	
DCLKTLK	PERIOD TIME	Th	325	371	438	DCLK	
	DISPLAY PERIOD	Thdisp	323	320	130	DCLK	
	DISTERNICE	тиатър		320		DCLIN	SYNC MODE BACK
							PORCH CONTROL BY
HSYNC	BACK PORCH	Thbp	3	43	43	DCLK	H_BLANKING[7:0]
	Brieff Forter	тпор		15	15	DOLL	SETTING Thbp=
							H_BLANKING[7:0]
	FRONT PORCH	Thfp	2	8	75	DCLK	_
	PULSE WIDTH	Thw	2	4	43	DCLK	
	PERIOD TIME	Tv	244)	260	289	HSYNC	
	DISPLAY PERIOD	Tvdisp		240		HSYNC	
			<i>y</i>				SYNC MODE BACK
			7				PORCH CONTROL
VSYNC	BACK PORCH	Tybp	2	12	12	HSYNC	
				-			SETTING Tvbp=
		7		$kO^{\gamma}$			V_BLANKING[7:0]
	FRONT PORCH	Tvfp	2	8	37	HSYNC	X
	PULSE WIDTH	Tvw	2	4	12	HSYNC	
	S NECESSARY TO KE NECESSARY TO KEE		AND Th	bp = 43 IN	SYNC M	MÓDE. DE	E MODE IS
		Splay		bite		OUL	
	Mergine	o d	disc				





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### 6. OPTICAL CHARACTERISTICS (NOTE 1)

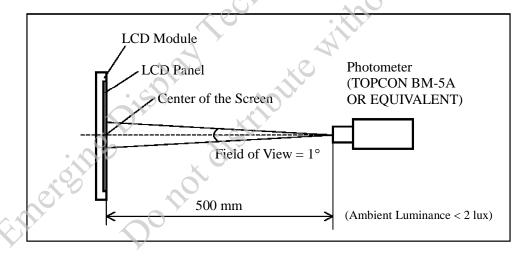
### 6.1 OPTICAL CHARACTERISTICS

Ta=25±2°C

ITEM		SYMBOL	COND	ITION	MIN.	TYP.	MAX.	UNIT	REMARK	
		$\theta y+$		θx=0°	70	80	_	deg		
VIEWING ANGLE		θу-	CD>10	CD>10		70	80	_	deg	NOTE (2)
		$\theta x+$	CR≥10		70	80	_	deg	NOTE (3)	
		θx-		θy=0°	70	80		deg		
CONTRAST RATIO (CENTER)		CR			600	800			NOTE (3)	
RESPONSE TIME		$T_R(rise)$	$\theta x=0^{\circ}, \theta y=0^{\circ}$			10	20	msec	NOTE (4)	
RESPONSE TIME		$T_F(fall)$				15	30	msec	NOTE (4)	
	WHITE	Wx	1		0.25	0.30	0.35		<b>O</b> '	
		Wy			0.26	0.31	0.36			
COLOD OF	RED	Rx			0.57	0.62	0.67	.0		
COLOR OF CIE COORDINATE		Ry	<i>y</i>		0.30	0.35	0.40		NOTE (5)	
(CENTER)	GREEN	Gx		$\theta y=0^{\circ}$	0.32	0.37	0.42		NOIL (3)	
(CEIVIER)	OKEEN	Gy		=3.3V	0.54	0.59	0.64		€.	
	BLUE	Bx		=3.3V	0.09	0.14	0.19		.0	
	BLUE	By	ILED=	=20mA	0.03	0.08	0.13		X	
THE BRIGHTNESS (MODULE(CENTER)		В	150	<i>y</i>	360	400	_	cd/m <sup>2</sup>	NOTE (6)	
THE UNIFORMITY MODULE	OF				70	P —		%	NOTE (7)	

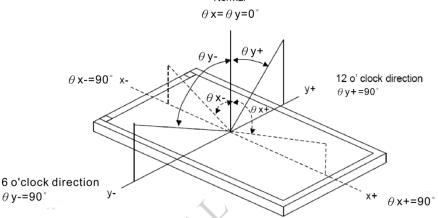
NOTE (1): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM.



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NOTE (2): DEFINITION OF VIEWING ANGLE:



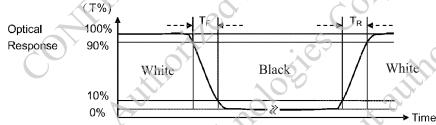
Normal

NOTE (3): DEFINITION OF CONTRAST RATIO (CR):

MEASURED AT THE CENTER POINT OF MODULE

CONTRAST RATIO(CR) =  $\frac{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "WHITE STATE"}}{\text{BRIGHTNESS MEASURED WHEN LCD IS AT "BLACK STATE"}}$ 

NOTE (4): DEFINITION OF RESPONSE TIME :  $T_R$  AND  $T_F$  THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR

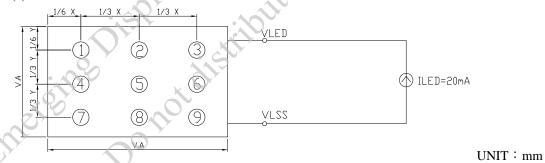


NOTE (5): DEFINITION OF COLOR CHROMATICITY

(a)THE 100% TRANSMISSION IS DEFINED AS THE TRANSMISSION OF LCD PANEL WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY POWERED ON. (b)MEASURED AT THE CENTER POINT OF MODULE

NOTE (6): MEASURED THE BRIGHTNESS OF WHITE STATE AT CENTER POINT.

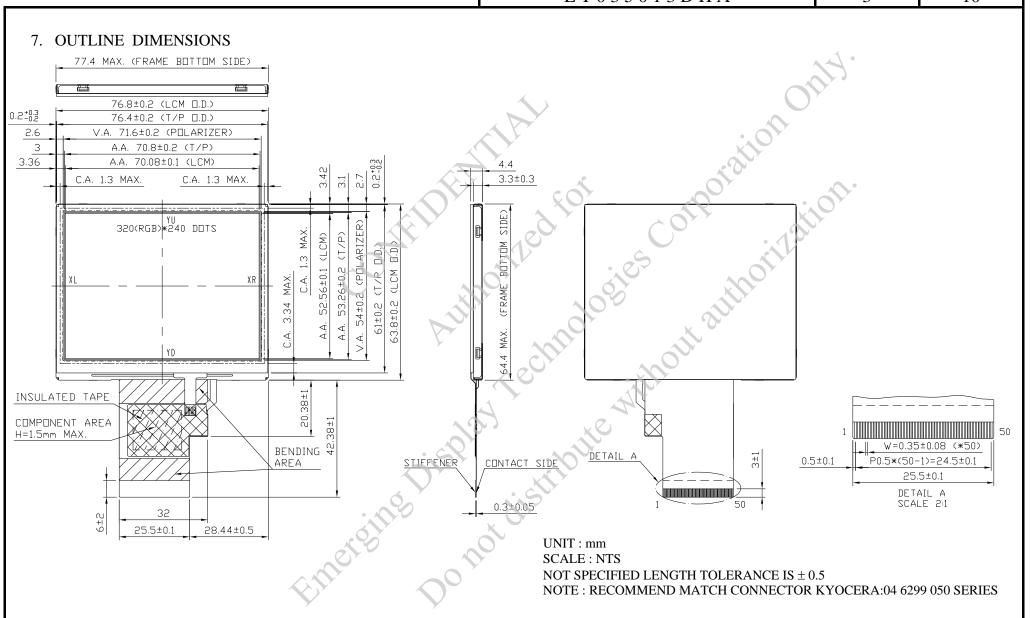
NOTE (7): (a) DEFINITION OF BRIGHTNESS UNIFORMITY



(b)THE BRIGHTNESS UNIFORMITY CALCULATING METHOD

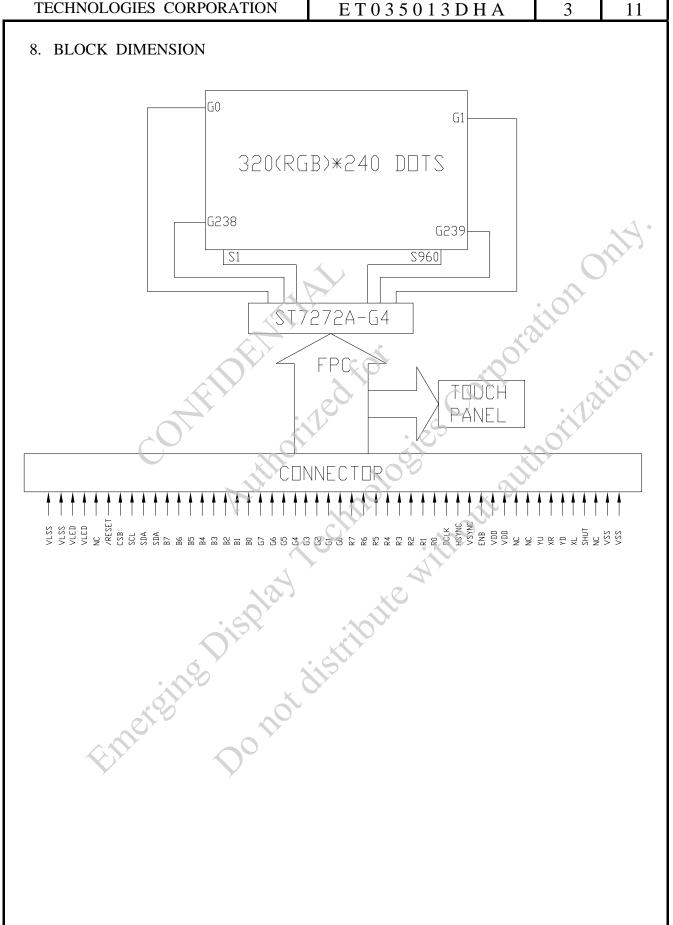
UNIFORMITY:  $\frac{\text{MINIMUM BRIGHTNESS}}{\text{MAXIMUM BRIGHTNESS}} *100\%$ 

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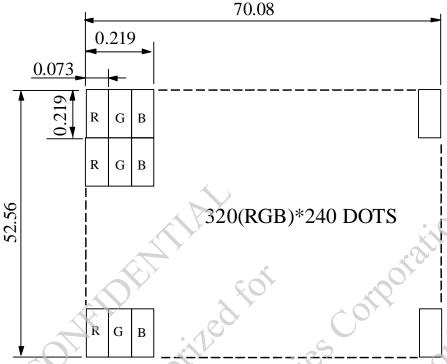
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UNIT : mm SCALE : NTS

NOT SPECIFIED TOLERANCE IS ± 0.11
DOTS MATRIX TOLERANCE IS ± 0.01

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### 10. INTERFACE SIGNALS

PIN NO.	SYMBOL	I/O/P	FUNCTION
1	VLSS	P	POWER SUPPLY FOR LED BACKLIGHT (CATHODE)
2	VLSS	P	POWER SUPPLY FOR LED BACKLIGHT (CATHODE)
3	VLED	P	POWER SUPPLY FOR LED BACKLIGHT (ANODE)
4	VLED	P	POWER SUPPLY FOR LED BACKLIGHT (ANODE)
5	NC	_	NON CONNECTION
6	/RESET	I	HARDWARE RESET
7	CSB	I	SPI INTERFACE CHIP SELECT BAR
8	SCL	I	SPI INTERFACE DATA CLOCK
9	SDA	I	SPI INTERFACE DATA
10	SDA	0	SPI INTERFACE DATA
11	В7	I	BLUE DATA BIT 7
12	B6	I	BLUE DATA BIT 6
13	B5	I	BLUE DATA BIT 5
14	B4	I	BLUE DATA BIT 4
15	В3	Í	BLUE DATA BIT 3
16	B2	1	BLUE DATA BIT 2
17	B1	) I	BLUE DATA BIT 1
18	В0	I	BLUE DATA BIT 0
19	G7	I	GREEN DATA BIT 7
20	G6	I	GREEN DATA BIT 6
21	G5	I	GREEN DATA BIT 5
22	G4	I	GREEN DATA BIT 4
23	G3	I	GREEN DATA BIT 3
24	G2	I	GREEN DATA BIT 2
25	G1	I	GREEN DATA BIT 1
26	G0	I	GREEN DATA BIT 0
27	R7	I	RED DATA BIT 7
28	R6	Po	RED DATA BIT 6
29	R5	I	RED DATA BIT 5
30	R4	I	RED DATA BIT 4
31	R3	I	RED DATA BIT 3
32	R2	I	RED DATA BIT 2
33	R1	I	RED DATA BIT 1
34	R0	I	RED DATA BIT 0

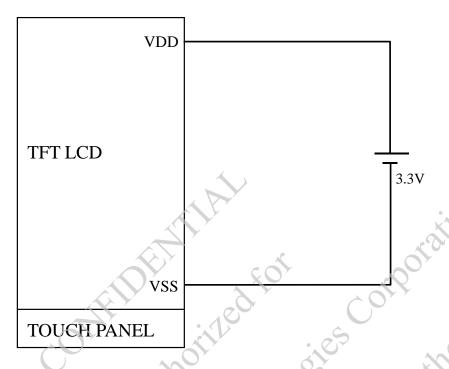
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PIN NO 35 36 37 38 39 40 41	DCLK HSYNC VSYNC ENB VDD	I/O/P I I I I	DOT DATA CLOCK	UNCTION				
35 36 37 38 39 40	DCLK HSYNC VSYNC ENB	I I I	DOT DATA CLOCK					
36 37 38 39 40	HSYNC VSYNC ENB	I I						
37 38 39 40	VSYNC ENB	I	HORIZONTAL SYNC INPUT	MODE SELECTION	DCLK	HSYNC	VSYNC	ENB
38 39 40	ENB		VERTICAL SYNC INPUT	SYNC MODE	INPUT	INPUT	INPUT	VSS
39 40			DATA ENABLE INPUT	DE MODE	INPUT	VSS	VSS	INPUT
40	100	P	ANALOG POWER SUPPLY					
	VDD	P	ANALOG POWER SUPPLY					
	NC		NON CONNECTION					
42	NC	_	NON CONNECTION					
43	YU	_	TOP PANEL					7
44	XR	_	RIGHT PANEL					
45	YD	_	BOTTOM PANEL	TOUCH PA	NEL			/
46	XL	_	LEFT PANEL			JAC		
			DISPLAY SHUT DOWN PIN T	O PUT THE I	ORIVE	R INT	O SLI	EEP
47	SHUT	I	MODE. CONNECT TO VCC FO	OR SLEEP MO	ODE.			
			CONNECT TO VSS FOR NORM	MAL OPERA	TING	MODI	E	<del>.</del> 6
48	NC		NON CONNECTION	~0	<b>&gt; &gt;</b>		X	7
49	VSS	P	GROUND				1.0	
50	VSS	P	GROUND					
	•	11196	Display Technic	Without				
	Cinera	0	OOTIL					

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### 11. POWER SUPPLY

### 11.1 POWER SUPPLY FOR LCM



### 11.2 POWER SUPPLY FOR LED BACKLIGHT



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#### 12. TOUCH PANEL SPECIFICATION

#### 12.1 ELECTRICAL CHARACTERISTICS

 $Ta = 25^{\circ}C$ 

ITEM	CONDITION	SPEC.	UNIT
LINEARITY		1.5	%
TEDMINAL DESIGNANCE	X AXIS	200 ~ 900	0
TERMINAL RESISTANCE	Y AXIS	200 ~ 900	22
INSULATION RESISTANCE	DC25V	20	$M\Omega$
INPUT VOLTAGE	_	5(TYP.)	V

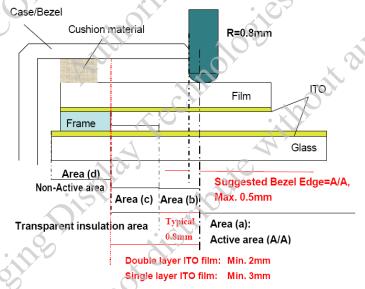
#### 12.2 PRECAUTIONS IN USE OF TOUCH PANEL

#### 12.2.1 PURPOSE :

IN ORDER TO PREVENT ACCIDENTAL USE AND PERFORMANCE DETERIORATION, PLEASE KEEP THE FOLLOWING PRECAUTIONS AND INHIBITED POINTS.

### 12.2.2 ITEM AND ILLUSTRATION:

( 1 ) STRUCTURE, AREA DEFINITION
THE STRUCTURE AND THE PERFORMANCE GUARANTEED AREA
OF THIS TOUCH PANEL ARE DEFINED BELOW:



THE ABOVE FIGURE IS OUR DESIGN RULE OF TOUCH PANEL.
IF IT CANNOT MEET YOUR REQUIREMENT, PLEASE CONTACT WITH OUR ENGINEERS FOR FURTHER DISCUSSION.
ABOVE FIGURE ILLUSTRATES THE RECOMMENDED BEZEL AND CUSHION DESIGN. IN ORDER TO PREVENT UNUSUAL PERFORMANCE DEGRADATION AND MALFUNCTION OF A TOUCH PANEL, PLEASE CARRY OUT THE SET CASE DESIGNING AND A TOUCH PANEL ASSEMBLING METHOD AFTER SURELY CONSIDERING THE DEFINITION OF EACH AREA ILLUSTRATED IN ABOVE FIGURE.

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AREA(a): ACTIVE AREA

THE ACTIVE AREA IS GUARANTEED THE POSITION DATA DETECTABLE PRECISION, OPERATION FORCE AND OTHER OPERATIONS. IT IS STRONGLY RECOMMENDED TO PLACE THE OPERATION BUTTON OR MENU KEYS WITHIN THE ACTIVE AREA. DUE TO STRUCTURE, THE ACTIVE AREA IS LESS DURABLE AT THE EDGE OR CLOSE TO THE EDGE.

AREA(b): OPERATION NON-GUARANTEED AREA
THIS AREA DOES NOT GUARANTEE A TOUCH PANEL OPERATION
AND ITS FUNCTION. WHEN THIS AREA IS PRESSED, TOUCH PANEL
SHOWS DEGRADATION OF ITS PERFORMANCE AND DURABILITY
SUCH AS A PEN SLIDING DURABILITY BECOMES ABOUT ONETENTH COMPARED WITH THE ACTIVE AREA (AREA-(A) AS
GUARANTEED AREA) AND ITS OPERATION FORCE REQUIRES
ABOUT DOUBLE. ABOUT 0.5 MM OUTSIDE FROM A BOUNDARY OF
THE ACTIVE AREA CORRESPONDS TO THIS AREA.

AREA(c): PRESSING PROHIBITION AREA
THE AREA WHICH FORBIDS PRESSING, BECAUSE AN EXCESSIVE
LOAD IS APPLIED TO A TRANSPARENT ELECTRODE (ITO) AND A
SERIOUS DAMAGE IS GIVEN TO A TOUCH PANEL FUNCTION BY
PRESSING.

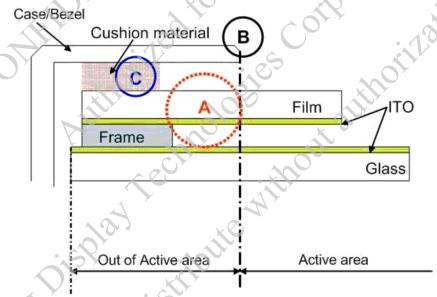
AREA(d): NON-ACTIVE AREA
THE AREA DOES NOT ACTIVATE EVEN IF PRESSED.

- (2) CAUTIONS FOR INSTALLING AND ASSEMBLING
  - (i) DO NOT GIVE EXCESSIVE STRAIN TO THE PRODUCT.
  - (ii) FLEXIBLE PATTERN CABLE IS CONNECTED TO THE BODY BY THERMAL PRESSURE METHOD. SO, DO NOT APPLY EXCESSIVE FORCES TO THE FLEXIBLE PATTERN. DO NOT ADD AN EXCESSIVE FORCE TO A FPC (FLEX TAIL) THAT MAKES PEELING OFF OF THE FPC FROM THE PRODUCT. DO NOT FIX, ADHERE OR MOUNT ANY ADDITIONAL GOODS ON THE FPC SUCH AS ADDITIONAL FILM/PLATE ON THE FPC, BECAUSE SUCH ADDITIONAL GOODS WILL APPLY A STRESS AT THE FPC BONDING AREA. IT MAY AFFECT THE CONDUCTIVITY OF FPC WITH TOUCH PANEL.
  - ( iii ) IN ORDER NOT TO APPLY LOAD ON THE DISPLAY, PROVIDE A CLEARANCE OF AT LEAST 0.3mm BETWEEN THE PRODUCT AND DISPLAY.

- (iv) WE RECOMMEND THE DESIGN OF A CASE OR BEZEL SHOULD COVERS THE BOUNDARY OF THE ACTIVE AREA INSIDE IN ORDER TO PREVENT AN OPERATION AT OUTSIDE OF THE ACTIVE AREA WHICH CAN NOT GUARANTEE THE FUNCTION OR DURABILITY (REFER TO ITEM 5.1.2. STRUCTURE, AREA DEFINITION).

  BEZEL'S EDGE PART MAY GUIDE THE PEN SLIDING ON THE SAME POSITION REPEATEDLY. IF THE BEZEL IS PLACED
- OUTSIDE OF THE ACTIVE AREA, IT MAY CAUSE THE DAMAGE OF THE ITO FILM.

  (v) PRESSING INSIDE OF BOUNDARY OF THE FRAME(PART (A) AS SHOWN IN BELOW) MAY CAUSES FAULT OPERATION. SO
- SHOWN IN BELOW) MAY CAUSES FAULT OPERATION, SO PLEASE DESIGN TO AVOID PRESSING OF TOUCH PANEL AT PART (A) SUCH AS HAVING GASKET/CUSHION AT PART (C). PARTICULARLY THE AREA (B) SHALL BE FREE FROM BURR. THE GASKET/CUSHION MATERIAL AT THE PART (C) SHOULD NOT BE EXCEEDED TO INSIDE OF THE BOUNDARY OF THE FRAME.



- ( vi ) TO PREVENT GIVING DISTORTION TO THE FILM OF THE PRODUCT AND PEELING OFF OF THE FILM FROM THE PRODUCT, DO NOT FIX THE FILM AND A SET CASE OR A SHOCK ABSORBING MATERIAL ADHERED TO A SET CASE BY ADHESION.
- (vii) WIPE OFF THE STAIN ON THE PRODUCT BY USING SOFT CLOTH MOISTENED WITH ETHANOL. TAKE CARE NOT TO ALLOW ETHANOL TO SOAK INTO THE JOINT OF UPPER FILM AND BOTTOM GLASS. IT MAY OTHERWISE CAUSE PEELING OR DEFECTIVE OPERATION. DO NOT USE ANY ORGANIC SOLVENT OR DETERGENT OTHER THAN ETHANOL.

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(viii) THE CORNERS OF THE PRODUCT ARE NOT CHAMFERED AND ARE SHARP.

WHEN POSITIONING AND FIXING THE PRODUCT ON THE CASE, PROVIDE A ROUND PART ON THE CORNER OF THE CASE SO AS NOT TO APPLY LOAD ON THE CORNER OF THE TRANSPARENT TOUCH PANEL.

( ix ) DO NOT PRESS THE FILM OF THE PRODUCT WHEN THIS PRODUCT IS BUILT INTO A SET.

### (3) CAUTIONS FOR OPERATION

- (i) OPERATE IT WITH A POLYACETAL PEN (TIP R0.8 OR OVER) OR A BELLY OF A FINGER WITHOUT APPLYING EXCESSIVE LOAD. NEVER USE ANY MECHANICAL PENCILS, BALL POINT PENS AND HARD FINGERTIPS WHO'S TIP IS HARD FOR INPUT, OTHERWISE MALFUNCTIONS MAY RESULT.
- ( ii ) THE INPUT POSITION MAY BE FLUCTUATED A LITTLE THROUGH LONG-TIME USE. IT IS DESIRABLE TO PROVIDE A ZERO-ADJUSTMENT FUNCTION BY USING A CIRCUIT AND SOFTWARE.
- (iii) OPERATION AT THE OUT OF ACTIVE AREA IS OUT OF OUR GUARANTEE. IT CAUSES A SERIOUS DAMAGE OF A TRANSPARENT ELECTRODE. DO NOT OPERATE AT THE OUT OF ACTIVE AREA.
- (iv) IN CASE OF CLEANING THE PART OF THE CASE BOUNDARY OF ACCOMPLISHED SET, USE A SOFT CLOTH WITH A FINGER BERRY OR A COTTON BUD. DO NOT CLEAN WITH A THING OTHER THAN THE FINGER SUCH AS HARD OR SHARP EDGES LIKE A FINGER NAIL ETC. ON THE CLOTH, BECAUSE IT CAUSE TRANSPARENT CONDUCTIVE FILM CRACKS. PLEASE ADVISE THIS PROHIBITION TO YOUR LAST CUSTOMERS.

#### 12.3 DURABILITY

### 12.3.1 STYLUS HITTING:

ONE MILLION TIMES OR OVER NO DAMAGE ON FILM SURFACE PEN : R8 mm SILICON RUBBER

LOAD: 250g

FREQUENCY : 240 times/min MEASUREMENT POSITION:

1 POINT OF TOUCH PANEL ACTIVE AREA

REPEATED: OVER 1,000,000 TIMES

#### 12.3.2 PEN TOUCH SLIDING DURABILITY:

100,000 TIMES OR OVER

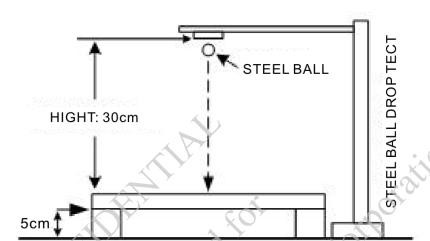
WRITING WITH R0.8mm PLASTIC STYLUS PEN; WRITING FORCE 150g IN ACTIVE AREA. SPEED IS 60mm/sec.

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### 12.4 STEEL BALL DROP TEST

THE PANEL BROKEN.

BY USING F9mm STEEL BALL FROM THE HEIGHT OF 30cm AND FALLING ON TOUCH PANEL SURFACE, MUST PASS BELOW CONDITIONS: APPEARANCE: THE APPEARANCE WITHOUT ANY CHANGE, INCLUDING



### 12.5 APPEARANCE INSPECTION

PURPOSE:

TO ESTABLISH APPEARANCE STANDARD AND MAINTAIN PRODUCT QUALITY.

SCOPE:

TOUCH PANEL VIEW AREA WITHIN TOUCH PANEL

#### 12.5.1 RULE:

INSPECTION CONDITION

- (A) ENVIRONMENTAL LUMINANCE 500 LUX.
- (B) DISTANCE BETWEEN HUMAN EYES AND PANEL: 30 cm (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT).
- (C) VISUAL ANGEL:  $> 60^{\circ}$
- (D) LIGHT SOURCE: FLUORESCENT LIGHT SOURCE.

#### 12.5.2 JUDGE CRITERION:

JUDGEMENT UNDER ABOVE MENTIONED CRITERION (PANEL MUST BE TESTED UNDER LIGHT TRANSPARENT),

TESTING GOODS DEFECT CAN BE VISIBLE WITHIN 10 SECONDS, WHICH WILL BE JUDGED AS MAJOR DEFECTS.

SAMPLING STANDARD:

THE SAMPLING STANDARD WILL BE CONFIRMED BY BOTH OF EDT AND CUSTOMER.

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INSPECTION ITEMS		SPEC.	JUDGE CRITERION	OPERATION GUIDELINE	
	W ≤ 0.11	mm & L≤10mm	ACCEPTABLE	REFL BACK GROUND	
SCRATCH	W > 0.1n	nm or L > 10mm	NOT ACCEPTABLE	TESTING GOODS FLUORESCENT LIGHT SOURCE	
LINEAR FOREIGN	W ≤ 0.1	mm & L ≤5mm	ACCEPTABLE	300mm =	
OBJECT	W > 0.1	mm or L >5mm	NOT ACCEPTABLE	environmental iuminance : 500lux  REFL	
GRANULAR FOREIGN	D	≤ 0.3mm	ACCEPTABLE	FLUORESCENT LIGHT SOURCE  TESTING GOODS  300mm	
OBJECT	D	>0.3mm	NOT ACCEPTABLE	ENVIRONMENTAL IUMINANCE : 500Lux	
PET BUBBLES	D	≤0.6mm	ACCEPTABLE		
	D >0.6mm		NOT ACCEPTABLE	D	
CHIP ON GLASS	CORNER	$X \le 3mm$ $Y \le 3mm$ $Z < t$ $(t = /thickness)$ $W \le 3mm$	ACCEPTABLE	Chip of glass	
	LDGL	$Y \le 3 \text{mm} \cdot Z < t$	Sir	Y	
Y < 3mm \ Z < t					

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#### 13. INSPECTION CRITERION

### 13.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.( E.D.T ) TO CUSTOMERS

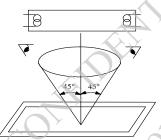
#### 13.2 INSPECTION CONDITIONS

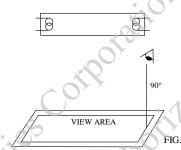
#### 13.2.1 (1)OBSERVATION DISTANCE: 45±5cm

(2) VIEWING ANGLE: ±45°

 $\pm 15^{\circ}$  (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A 90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°





THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECTS TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECTS TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

### 13.2.2 ENVIRONMENT CONDITIONS:

AMBIENT TEMPERATURE		
AMBIENT HUMIDITY		
COSMETIC INSPECTION	600~800 Lux	
FUNCTIONAL INSPECTION	300~500 Lux	
INSPECTION TIME		
	BIENT HUMIDITY  COSMETIC INSPECTION  FUNCTIONAL INSPECTION	

### 13.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

### 13.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY (a)APPLICABLE STANDARD:

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL: MAJOR DEFECT: AQL 0.65 MINOR DEFECT: AQL 1.0

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### 13.3 INSPECTION STANDARDS

### 13.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED     DISPLAY FUNCTION, FOR ALL     AND SPECIFIED DOTS     EX: DISCONNECTION, SHORT     CIRCUIT ETC	
MAJOR DEFECT	2.BACKLIGHT	NO LIGHT     FLICKERING AND OTHER     ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	SUBJECT TO INDIVIDUAL     ACCEPTANCE SPECIFICATIONS	
	1.DISPLAY ZONE	<ul> <li>BLACK/WHITE SPOT</li> <li>BUBBLES ON POLARIZER</li> <li>NEWTON RING</li> <li>BLACK/WHITE LINE</li> <li>SCRATCH</li> <li>CONTAMINATION</li> <li>UNEVEN COLOR SPREAD</li> </ul>	don
MINOR DEFECT	2.BEZEL ZONE	• STAINS • SCRATCHES • FOREIGN MATTER	1.0
	3.SOLDERING 4.DISPLAY ON	<ul> <li>INSUFFICIENT SOLDER</li> <li>SOLDERED IN INCORRECT POSITION</li> <li>CONVEX SOLDERING SPOT</li> <li>SOLDER BALLS</li> <li>SOLDER SCRAPS</li> <li>LIGHT LINE</li> </ul>	
EMERCE	(ALL ON)		

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### 13.3.2 MODULE DEFECTS CLASSIFICATION

NO.	ITEM	CRITERIA		
1	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND SPEC		
2	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND SPEC		
3	DOT DEFECT	(1)INSPECTION PATTERN: FULL WHITE, FULL BLACK, RED, GREEN AND BLUE SCREENS.  (2)  ITEMS  ACCEPTABLE COUNT  BRIGHT DOT  DARK DOT  TOTAL BRIGHT AND DARK DOTS  N≤2  DARK DOT  TOTAL BRIGHT AND DARK DOTS  N≤4  NOTE:  1. THE DEFINITION OF DOT:  THE SIZE OF A DEFECTIVE DOT OVER 1/2 OF WHOLE DOT IS REGARDED AS ONE DEFECTIVE DOT.  2. BRIGHT DOT:  DOTS APPEAR BRIGHT AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER BLACK PATTERN.  THE BRIGHT DOT DEFECT MUST BE VISIBLE THROUGH 5% ND FILTER  3. DARK DOT:  DOTS APPEAR DARK AND UNCHANGED IN SIZE IN WHICH LCD PANEL IS DISPLAYING UNDER PURE RED, GREEN, BLUE PICTURE.		
4	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA			
5	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)	AVERAGE DIAMETER (mm): D NUMBER OF PIECES PERMITTED $D \le 0.15$ IGNORE $0.15 < D \le 0.5$ 4 NONE $0.5 < D$ NONE $0.5 < D$ NOTE : DIAMETER $D = (a+b)/2$		

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NO.	ITEM	CRITERIA		
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED
			D ≤ 0.25	IGNORE
		BUBBLE ON THE	$0.25 < D \le 0.5$	N ≤ 5
		POLARIZER	0.5 < D	NONE
		DIDT / DENT /	D < 0.25	IGNORE
		DIRT / DENT / SURFACE STAINS	$0.25 < D \le 0.35$	N ≤ 3
		SURFACE STAINS	0.35 < D	NONE
			D < 0.1	IGNORE
		CF FAIL / SPOT	$0.1 < D \le 0.3$	N ≤ 3
	BUBBLES OF POLARIZER		0.3 < D	NONE
	CONT	OBSERV (3)THE DEF AS FOLL	ED WHEN THE MODULE INITION OF AVERAGE D	S DEFINED AS IT CAN BE IS POWER ON. IAMETER, D IS DEFINED
7	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL OR HORIZONTAL LINE DEFECT IS NOT ALLOWED		
8	MURA ON DISPLAY	IT'S OK IF MURA IS	SLIGHT VISIBLE THROU	GH 5% ND FILTER
	UNEVEN COLOR	A 0	- NO	
9	SPREAD,	(1)TO BE DETERMIN	IED BASED UPON THE ST	TANDARD SAMPLE.
	COLORATION	1		
10	BEZEL APPEARANCE	PRINTS STAINS C	HAVE RUST, BE DEFORM OF OTHER CONTAMINATI MPLY WITH JOB SPECIFION	ION.
11	PCB CONTROL OF THE PCB	THE SEAL AREA THAN THREE PLA (2)NO OXIDATION C (3)PARTS ON PCB M CHARACTERISTIC THERE SHOULD E PARTS. (4)THE JUMPER ON CHARACTERISTIC (5)IF SOLDER GETS	OR CONTAMINATION PCE UST BE THE SAME AS OF C CHART. BE NO WRONG PARTS, MI THE PCB SHOULD CONFO	E SHOULD BE NO MORE B TERMINALS. N THE PRODUCTION ISSING PARTS OR EXCESS ORM TO THE PRODUCT ED PAD, ZEBRA PAD OR

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NO. ITEM CRITERIA  (I)NO SOLDERING FOUND ON THE SPECIFIED PLACE (2)INSUFFICIENT SOLDER (a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BY "HEEL" OF LEAD AND PAD  SOLDER FILLET  (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  - SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THE SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTL.	
(2)INSUFFICIENT SOLDER (a)LSI, IC  A POOR WETTING OF SOLDER IS BETWEEN LOWER BETWEEN L	
(a)LSI, IC A POOR WETTING OF SOLDER IS BETWEEN LOWER BI "HEEL" OF LEAD AND PAD  (b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT FI WETTING  SOLDER FILLET  1/2  SOLDER FILLET  1/2  SOLDER FILLET  SOLDER FILLET  (3)PARTS ALIGNMENT (a)LSI, IC	
A POOR WETTING OF SOLDER IS BETWEEN LOWER BETHEEL" OF LEAD AND PAD  (b)CHIP COMPONENT  · SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  · SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THE SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
(b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER FILLET  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	DENID OD
(b)CHIP COMPONENT SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH, SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	DEND OK
(b)CHIP COMPONENT  SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDERING  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
(b)CHIP COMPONENT  SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDERING  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
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SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	1
SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	22
SOLDER IS LESS THAN 50% OF SIDES AND FRONT F. WETTING  SOLDER FILLET  1/2  SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SOLDER FILLET  1/2  - SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	FACE
SOLDER FILLET  1/2  • SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS TH. SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	HeL
SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THE SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	<b>Y</b>
SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SOLDERING SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SOLDERING SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	-0
SOLDERING SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	:40°
SOLDERING SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	
SIDES AND FRONT SURFACE AREA ARE COVERED  SOLDER  (3)PARTS ALIGNMENT (a)LSI, IC	1.0
(3)PARTS ALIGNMENT (a)LSI, IC	IAN 25% OF
(3)PARTS ALIGNMENT (a)LSI, IC	
(3)PARTS ALIGNMENT (a)LSI, IC	
(a)LSI, IC	
(a)LSI, IC	
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NO.	ITEM	CRITERIA
110.	TIEM	(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12	SOLDERING	
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
14	GENERAL APPEARANCE	<ul> <li>(1)NO OXIDATION, CONTAMINATION. CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP.</li> <li>(2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP.</li> <li>(3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT.</li> <li>(4)THE IC ON THE TCP MAY NOT BE DAMAGED. CIRCUITS.</li> <li>(5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER.</li> <li>(6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING.</li> <li>(COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR.</li> <li>(7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED.</li> <li>(8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET.</li> <li>(9)LCD PIN LOOSE OR MISSING PINS.</li> <li>(10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET.</li> <li>(11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET.</li> <li>(12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.</li> </ul>

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NO.	ITEM	CRITERIA		
		THE LCD WITH EXTENSIVE (	CRACK IS NOT ACCEPTABLE	
		GENERAL GLASS CHIP:	a b c	
		, b	$\leq$ t/2 $<$ VIEWING AREA $\leq$ 1/8X	
		, c a	$t/2 > , \le 2t \qquad \qquad \le W/2 \qquad \qquad \le 1/8X$	
			*W=DISTANCE BETWEEN	
			SEALANT AREA AND LCD	
			PANEL EDGE	
			X = LCD SIDE LENGTH	
			t = GLASS THICKNESS	
		W C		
		a		
		b		
			*O*	
		C		
			χ.Ο.	
			-O <sub>2</sub>	
		a	.0	
		CORNER PART:	$\begin{array}{ c c c c c }\hline a & b & c \\\hline & \leq t/2 & < VIEWING AREA & \leq 1/8X \\\hline \end{array}$	
		b	$\begin{array}{ c c c c c c }\hline > t/2 & < VIEWINGTREET & \le 1/6X\\\hline > t/2 & , \le 2t & \le W/2 & \le 1/8X\\\hline \end{array}$	
			*W=DISTANCE BETWEEN	
15	CRACKED GLASS	C	SEALANT AREA AND LCD	
		a	PANEL EDGE	
			X = LCD SIDE LENGTH	
			t = GLASS THICKNESS	
		CHIP ON ELECTRODE PAD	a b c	
		a	≤t ≤ 0.5mm ≤ 1/8X	
			* X=LCD SIDE WIDTH	
		6	t=GLASS THICKNESS	
		T C	2	
			a b c	
		1.457	$\leq$ t $\leq$ 1/8X $\leq$ L	
	4		*X=LCD SIDE WIDTH	
	4		t = GLASS THICKNESS	
	S.Mereine		L=ELECTRODE PAD LENGTH	
			①IF GLASS CHIPPING THE ITO TERMIN	
	, 0,		OVER 2/3 OF THE ITO MUST REMAIN	
			AND BE, INSPECTED ACCORDING TO	
		a	ELECTRODE TERMINAL SPECIFICATIONS	
			②IF THE PRODUCT WILL BE HEAT	
			SEALED BY THE CUSTOMER,	
			THE ALIGNMENT MARK MUST NOT	
			BE DAMAGED	
	<u> </u>	1	1	

### EMERGING DISPLAY

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TECHNOLOGIES CORPORATION

#### 14. RELIABILITY TEST

#### 14.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION	
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS	
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS	
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS	
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS	
5	/HUMIDITY TEST	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C , 90% RH 240 HRS	
6	THERMAL SHOCK (NON-OPERATION)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION:  +80°C  -30°C  30 min 3 min 1 CYCLE	
7	(FLECTROSTATIC	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV (ACCORDING TO IEC-61000-4-2)	

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

### 14.2 TESTING CONDITIONS AND INSPECTION CRITERIA

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FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM TEMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 14.1, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST	REFER TO SPECIFICATION	AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

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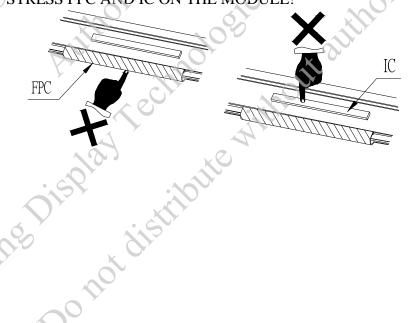
#### 15. CAUTION

#### 15.1 OPERATION

- 15.1.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 15.1.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 15.1.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST.
- 15.1.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.

  IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 15.1.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

  DO NOT STRESS FPC AND IC ON THE MODULE!



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#### 15.2 HANDLING

- 15.2.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGHHOLE-PAD .
- 15.2.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED .
- 15.2.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 15.2.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 15.2.5 DON'T GIVE EXTERNAL SHOCK.
- 15.2.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 15.2.7 LIQUID CRISTAL IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW
  WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC.
  WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 15.2.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 15.2.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS. AND SOLVENT
- 15.2.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 15.2.11 REWIRING: NO MORE THAN 3 TIMES.